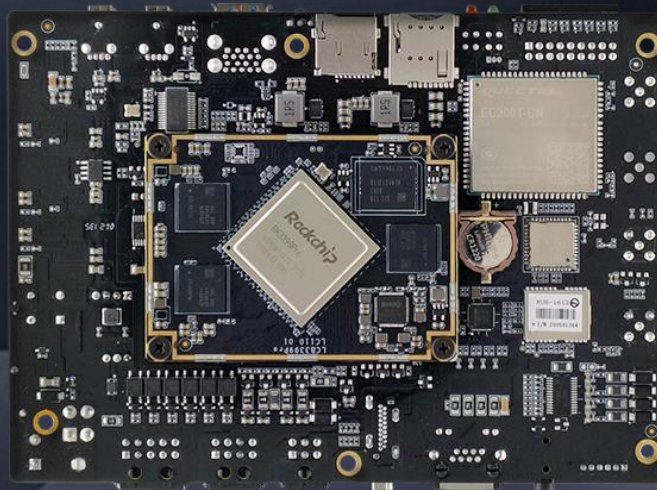




LKD3399Pro Development Board

Datasheet

V1.0



Shanghai Neardi Technology Co., Ltd.

www.neardi.com

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Version History

Version	Date	Description
V1.0	2022/8/23	Initial version

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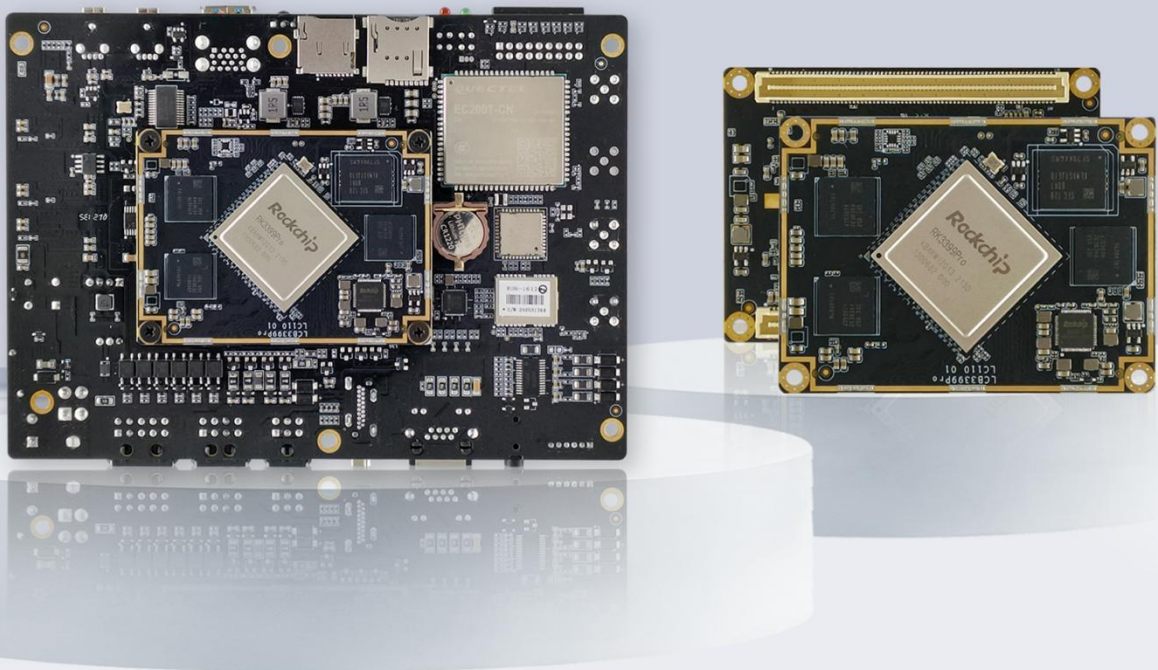
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1.Product Introduction

The LKD3399Pro intelligent computer is a portable computing host developed based on the Rockchip RK3399Pro platform, designed for scenarios requiring extensive visual computing. It features an integrated NPU computing unit with 3.0 TOPS of computational power and supports a variety of algorithmic models. This product serves as a foundational device in AI scenarios, equipped with a rich set of hardware interfaces. Users only need to port algorithms to this platform to quickly implement products.

The LKD3399Pro development board supports input from up to 5 AHD cameras and is also compatible with various depth cameras, making it suitable for machine vision and ADAS product development. AHD cameras are widely used in the vehicle field, employing coaxial transmission that can reach tens of meters, and they use industry-standard aviation plug connections, which are stable, reliable, and easy to install.

The LKD3399Pro vision host integrates dual-band WIFI 802.11a/b/g/n/ac, BT5.0 low-power Bluetooth, GPS+BD dual-mode navigation, septa-mode universal 4G communication, and a 9-axis motion sensor. It supports a variety of communication interfaces, including RS232, RS485, CAN, and 1000M Ethernet. The rich set of interfaces allows users to develop a wide range of excellent products.



2. Function Overview



High-Performance Processor

CPU	Dual-core Cortex-A72 and quad-core Cortex-A53 architecture, with a clock speed up to 1.8GHz, offering high performance and low power consumption.
GPU	ARM Mali-T860MP4 GPU, supporting AFBC (Advanced Frame Buffer Compression).
NPU	3 TOPS of computational power.
VPU	Capable of 4K/1080P video encoding and decoding, with 4K display output.
DDR	LPDDR4/4x, with options for 3GB or 6GB.
eMMC	eMMC 5.1, with options for 16GB or 64GB.



Rich Interfaces

5 AHD high-definition cameras, 4 USB cameras.

Dual-band WIFI, BT5.0, 2G/3G/4G universal data transmission, GPS/Beidou dual-mode positioning.

2 USB 3.0 OTG ports, 2 USB 2.0 HOST ports.

1 HDMI port.

1 CANBUS, 1 RS485, 2 RS232 interfaces.



Operating System

Android

Linux (Buildroot / Debian / Ubuntu)



Open Source Materials

WIKI Documentation <http://www.neardi.com/cms/en/wiki.html>

Quick Start

Firmware Upgrade

Android Development

Linux Development

Kernel Drivers

DEMO

System Customization

Accessories

Frequently Asked Questions (FAQ)

Release Notes

Hardware Materials

Chip Datasheet

Product 2D/3D Drawings

Core Board Pin Definitions

Baseboard Reference Schematic

Baseboard Reference PCB

Key Bill of Materials (BOM)

Software Materials

Firmware Tools and Drivers

Android Source Code and Images

U-Boot and Kernel Source Code

Debian/Ubuntu/Buildroot System Files

3. Technical Specifications

Basic Parameters

SOC	RK3399Pro; a dual-core Cortex-A72 plus quad-core Cortex-A53 architectural processor.
GPU	Mali-T860MP4 GPU, supporting OpenGL ES 1.1/2.0/3.0/3.1, OpenVG 1.1, OpenCL, DirectX 11; supports AFBC (Advanced Frame Buffer Compression).
NPU	3 TOPS computational power; supports 8-bit/16-bit operations; compatible with TensorFlow and Caffe models.
VPU	Capable of 4K VP9 and 4K 10-bit H265/H264 video decoding, up to 60fps at 1080P; multi-format video decoding (WMV, MPEG-1/2/4, VP8); 1080P video encoding, supporting H.264 and VP8 formats.
DDR	LPDDR4/LPDDR4X, with options for 3GB or 6GB.
eMMC	eMMC 5.1, with options for 16GB, 32GB, 64GB, or 128GB.
PMU	RK806
OS	Android / Ubuntu / Buildroot / Debian

Hardware Specifications

Power	DC 9V - 36V
USB	2*Type-A USB3.0 HOST, 2*Type-A USB2.0 OTG
Display output	1*Type-A HDMI 2.0
Audio	ø3.5mm audio out and microphone input

Storage	Micro SD card with SDIO 3.0 protocol
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Connectivity	1*Uart, 2*RS232, 1*RS485
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	1*10/100/1000Mbps Ethernet
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Net work	Wi-Fi 2.4GHz/5GHz,802.11a/b/g/n/ac;
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	BT V5.0 with BLE supported
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Camera Interface	5*AHD input up to 1920*1080@30fps per channel
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Other Parameters

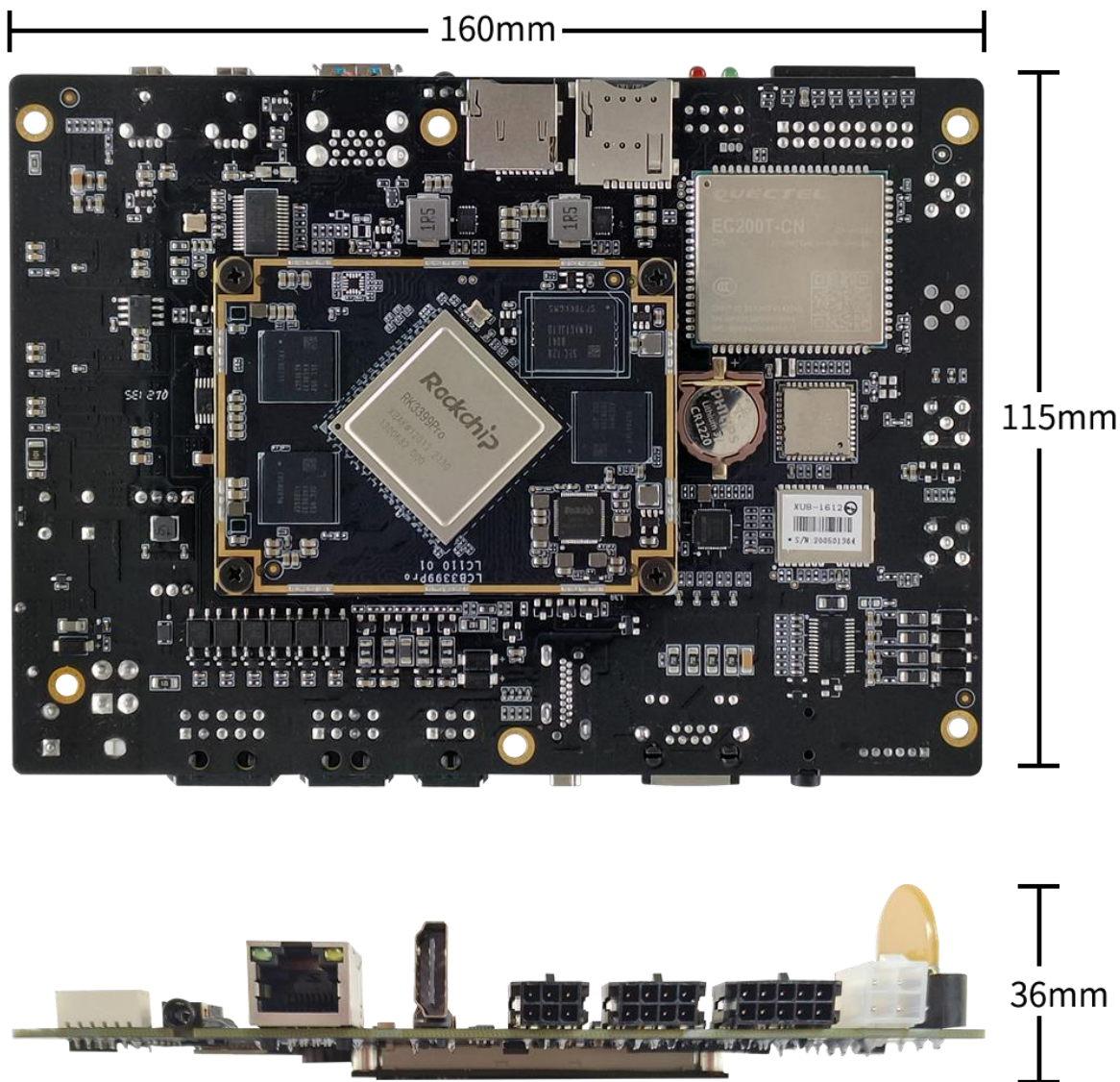
Dimensions	Length * Width * Height (mm) 160*115*36
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Operating Temperature	-10 ~ 70°C
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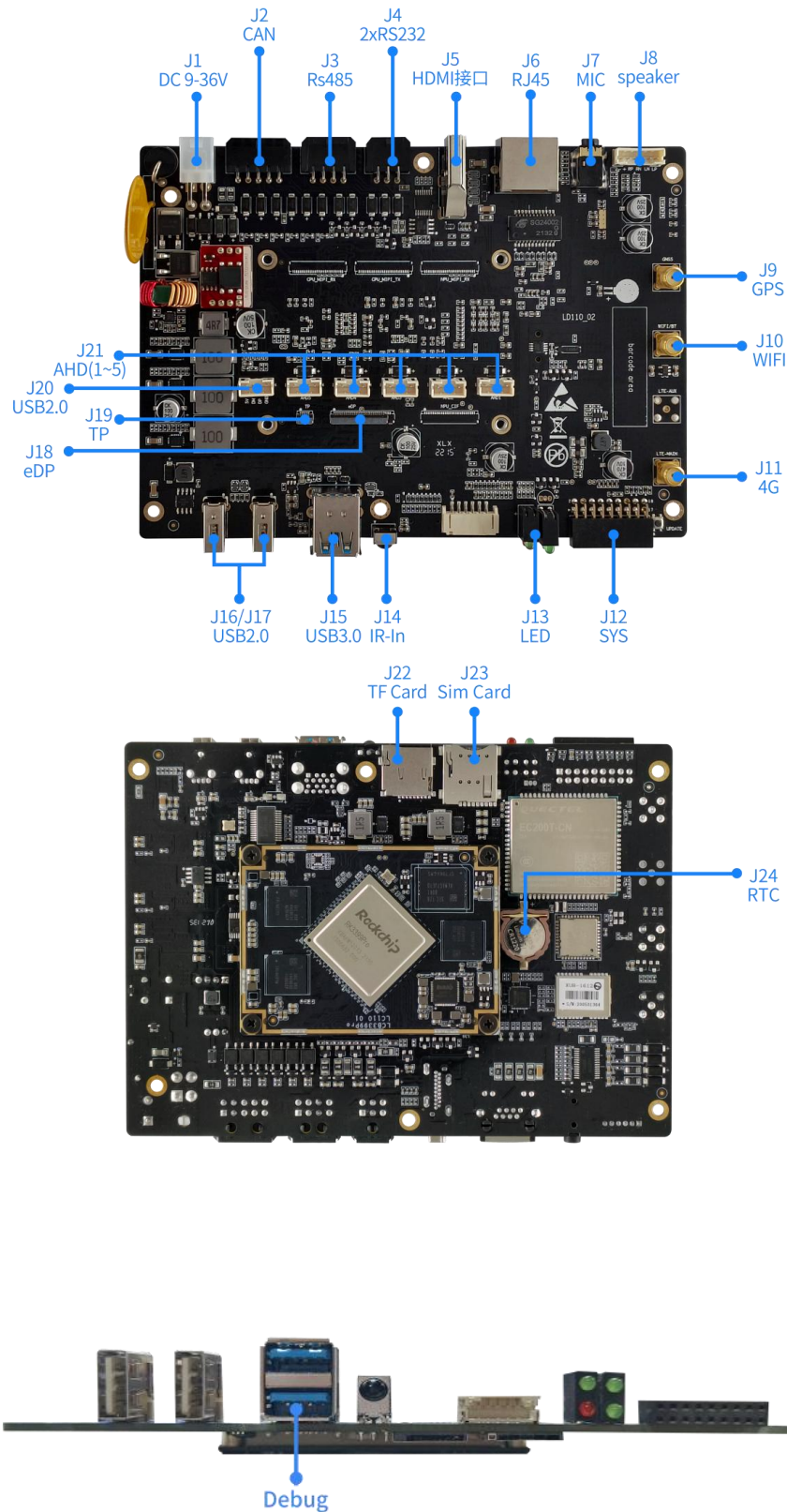
Weight	Approximately 183.9 g (excluding peripherals)
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4. Appearance and Dimensions

4.1 Appearance



5.Interface Definition



Part reference	Part Name	Part Description
J1	DC 9-36V	Power input and high/low level detection, supports 9V to 36V operating voltage; Automotive connector, 4.2mm pitch, 4Pin right-angled double row, Molex, 5569-04A2;
J2	CAN	CAN bus and 6-channel input signal detection, 3kV isolation design, can withstand $\pm 36V$ voltage; Automotive connector, 3.0mm pitch, 10Pin right-angled double row, Molex, 43045-1000;
J3	RS485	RS485 bus and 4-channel 12V voltage signal output, $\pm 15kV$ ESD protection; Automotive connector, 3.0mm pitch, 8Pin right-angled double row, Molex, 43045-0800;
J4	2*RS232	Two RS232 buses, $\pm 15kV$ ESD protection; Automotive connector, 3.0mm pitch, 6Pin right-angled double row, Molex, 43045-0600;
J5	HDMI	HDMI 2.0a supporting 4K 60Hz display, supports HDCP 1.4/2.2; Type-A female socket;
J6	RJ45	Gigabit 1000M Ethernet; RJ45 socket;
J7	MIC	Left and right channel output, microphone input, national standard; $\varnothing 3.5mm$ headphone jack, four-section;
J8	Speaker	Dual-channel stereo output and analog microphone input, 10W/8 惟 2CH; Aviation plug male head, GX12-6 core;
J9	GPS	Navigation and positioning antenna, supports GPS and Beidou dual-mode positioning; SMA socket, external thread internal hole;

J10	WIFI	WIFI/Bluetooth antenna;
J11	4G	4G antenna, supports full network, SMA socket, external thread internal hole;
J12	SYS-CTL	System control or debugging;
J13	LED	Power indicator light; 4G network status indicator light; Custom status indicator light, GPIO controlled;
J14	IR-IN	Sensor interface;
J15	USB3.0	USB3.0, type-A female socket, double layer;
J16/17	USB2.0	USB2.0, type-A female socket;
J18	eDP	eDP interface;
J19	TP	TP interface;
J20	USB2.0	USB2.0, 4pin
J21	AHD1-AHD5	Analog high-definition video signal input, supports all formats and resolutions of AHD signals;
J22	SD card	Compatible with SDIO 3.0 protocol, supports system boot;
J23	SIM card	Micro sim card slot for Mini-PCIe 4G LTE module;
J24	RTC	RTC battery compartment.

6. Pin Definition

AHD1-AHD5

Pin number	Pin name	Pin description
1	VCC12V_AHD	AHD Camera Power Supply Positive Terminal, 12V-0.5A
2	GND	AHD Camera Ground (GND)
3	NC	No Connection (NC)
4	AHD_video	AHD Camera Video Input

SPEAKER

Pin number	Pin name	Pin description
1	SPK_LP	Speaker Left Channel Positive Terminal
2	SPK_LN	Speaker Left Channel Negative Terminal
3	SPK_RN	Speaker Right Channel Negative Terminal
4	SPK_RP	Speaker Right Channel Positive Terminal
5	Mic_P	Analog Microphone Positive Terminal
6	Mic_N	Analog Microphone Negative Terminal

CAN/INPUT

Pin number	Pin name	Pin description
1	CAN_H	CAN Bus High-Level Signal, with electrical isolation of more than 3KV.
2	GND	Reference Ground for Input Detection Signal.

3	GPIO_IN1	Input Detection Signal, with electrical isolation of more than 3KV, supports 0~36V
4	GPIO_IN3	Input Detection Signal, with electrical isolation of more than 3KV, supports 0~36V
5	GPIO_IN5	Input Detection Signal, with electrical isolation of more than 3KV, supports 0~36V
6	CAN_L	CAN Bus Low-Level Signal, with electrical isolation of more than 3KV.
7	GND	Reference Ground for Input Detection Signal.
8	GPIO_IN2	Input Detection Signal, with electrical isolation of more than 3KV, supports 0~36V.
9	GPIO_IN4	Input Detection Signal, with electrical isolation of more than 3KV, supports 0~36V.
10	GPIO_IN6	Input Detection Signal, with electrical isolation of more than 3KV, supports 0~36V.

RS485/OUTPUT

Pin number	Pin name	Pin description
1	OUTPUT1	Output Control Signal
2	OUTPUT3	Output Control Signal
3	GND	Reference Ground for Output Control Signal
4	RS485_A	RS485 Bus A Output Signal

5	OUTPUT2	Output Control Signal
6	OUTPUT4	Output Control Signal
7	GND	Reference Ground for Output Control Signal
8	RS485_B	RS485 Bus B Output Signal

RS232

Pin number	Pin name	Pin description
1	RS232_TX1	Transmission for the first RS232 bus.
2	GND	Reference Ground for the RS232 bus.
3	RS232_TX2	Transmission for the second RS232 bus.
4	RS232_RX1	Reception for the first RS232 bus.
5	GND	Reference Ground for the RS232 bus.
6	RS232_RX2	Reception for the second RS232 bus.

7.Application Scenarios



AI



Machine Vision



Industrial Control



Energy and Power



Smart Tablet



VR



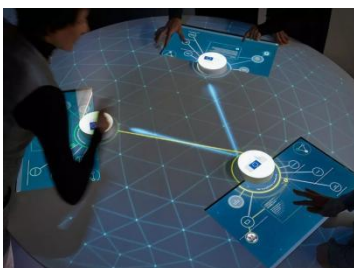
Smart Logistics



New



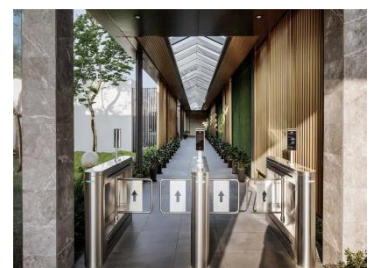
Smart Commercial



Object Recognition



Vehicle terminal



Security Surveillance

8.Ordering Model

Product Model	Status	CPU	DDR	eMMC	Operating Temperature
LP11031600	ACTIVE	RK3399Pro	3GB	16GB	-10°C - 70°C
LP11061600	ACTIVE	RK3399Pro	6GB	16GB	-10°C - 70°C
LP11066400	ACTIVE	RK3399Pro	6GB	64GB	-10°C - 70°C

*For customized non-standard orders, please contact us via email at sales@neardi.com.

9.About Near di

Shanghai Near di Technology Co., Ltd., established in 2014, is a national-level high-tech enterprise, a strategic partner of Rockchip, and an authorized agent for Black Sesame Technologies. We focus on the research and development and production of enterprise-level open-source hardware platforms, offering customers core modules, industry-specific boards, development boards, touch panels, and industrial control hosts. Adhering to the core philosophy of technological innovation and professional service, leveraging Near di Technology's technical strengths and industry experience, we assist our partners in achieving rapid mass production of their products.

Company Advantages

Software Design / Custom OS / Product ODM / Bulk Delivery

Products

Rockchip

System On Module



LCB3588/J



LCB3568/J



LCB3566



LCB3399Pro



LCB3399

Development Board



LKD3588/J



LKD3568/J



LKD3566



LKD3399Pro



LKD3399

Embedded Computer



LPB3588



LPM3588



LPC3588



LPB3568



LPB3399Pro

Black Sesame Technologies



SOM-A-A1000



SOM-π-A1000



SOM-B-A1000



SOM-A1000 Development kit

Vehicle Terminal



LPA3588



LPA3568



LPA3399Pro



LPS3399Pro

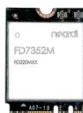
WIFI Module



FD7352S



FD7352P



FD7352M



FD7155U



FD7256S